# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

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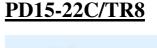


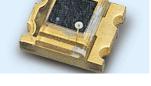


## Technical Data Sheet Silicon PIN Photodiode

#### Features

- Fast response time
- High photo sensitivity
- Small junction capacitance
- Pb free
- The product itself will remain within RoHS compliant version.





#### Descriptions

• PD15-22C/TR8 is a high speed and high sensitive PIN photodiode in miniature flat top view lens SMD package and it is molded in a water clear plastic. The device is Spectrally matched to visible and infrared emitting diode.

#### Applications

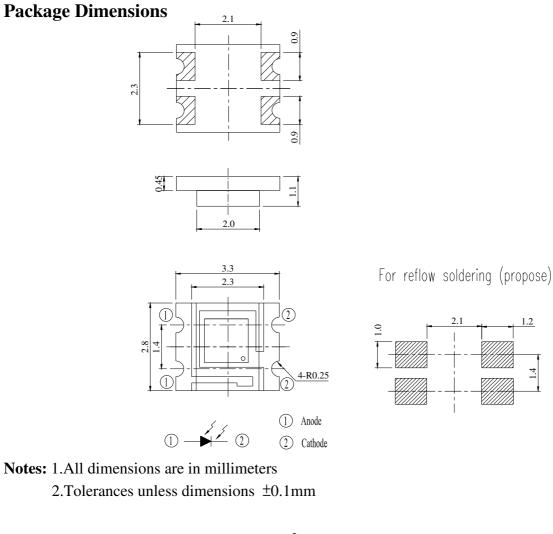
- High speed photo detector
- Copier
- Game machine

#### **Device Selection Guide**

LED Part No.	Chip	Lens Color	
	Material		
PD15-22C/TR8	Silicon	Water clear	

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## Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Units
Reverse Voltage	V <sub>R</sub>	32	V
Operating Temperature	T <sub>opr</sub>	-25 ~ +85	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	°C
Soldering Temperature*1	T <sub>sol</sub>	260	°C
Power Dissipation at(or below)	Pc	150	mW
25°C Free Air Temperature			

**Notes:** \*1:Soldering time  $\leq$  5 seconds.

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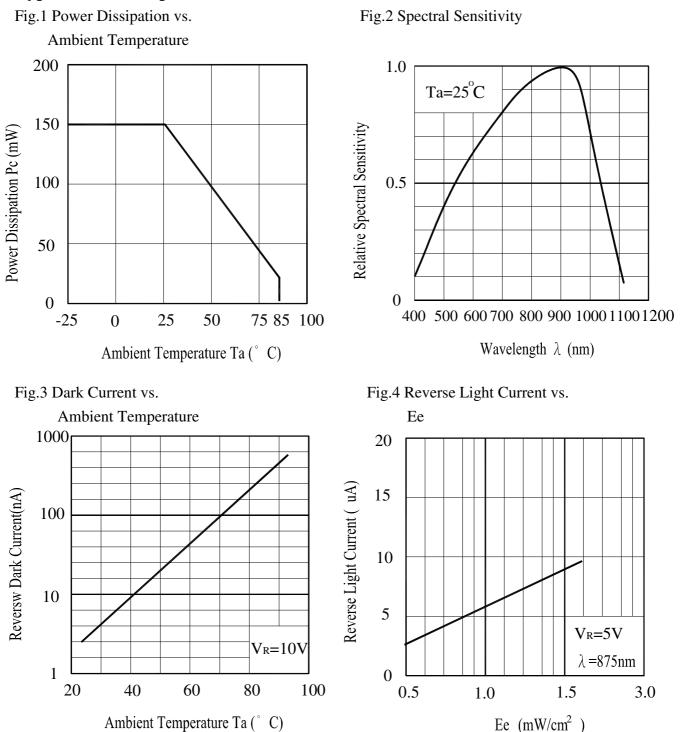
## Electro-Optical Characteristics (Ta=25°C)

Parameter	Parameter Symbol Condition		Min	Тур	Max	Unit
Rang Of Spectral Bandwidth	λ	10% of $\lambda_P$	400		1100	nm
Wavelength Of Peak Sensitivity	λ Ρ			940		nm
Open-Circuit Voltage	V <sub>OC</sub>	Ee=5mW /cm <sup>2</sup> $\lambda_{P}$ =940nm		0.41		V
Short-Circuit Current	I <sub>SC</sub>	$\frac{\text{Ee}=1\text{mW}/\text{cm}^2}{\lambda_{\text{P}}=875\text{nm}}$	4.0	6.5		μA
Reverse Light Current	IL	$Ee=1mW / cm^{2}$ $\lambda_{P}=875nm$ $V_{R}=5V$	4.2	6.5		μA
Dark Reverse Current	I <sub>D</sub>	$\begin{array}{c} \text{Ee=0mW /cm}^2\\ \text{V}_{\text{R}}\text{=}10\text{V} \end{array}$			10	nA
Reverse Breakdown Voltage	B <sub>VR</sub>	Ee=0mW /cm <sup>2</sup> $I_R$ =100 $\mu$ A	32	170		V
Total Capacitance	Ct	$Ee=0mW / cm^{2}$ $f=1MHz$ $V_{R}=5V$		6		pF
Rise Time	t <sub>r</sub>	V <sub>R</sub> =5V		10		
Fall Time	t <sub>f</sub>	$R_L=1000\Omega$		10		nS

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#### **Typical Electro-Optical Characteristics Curves**



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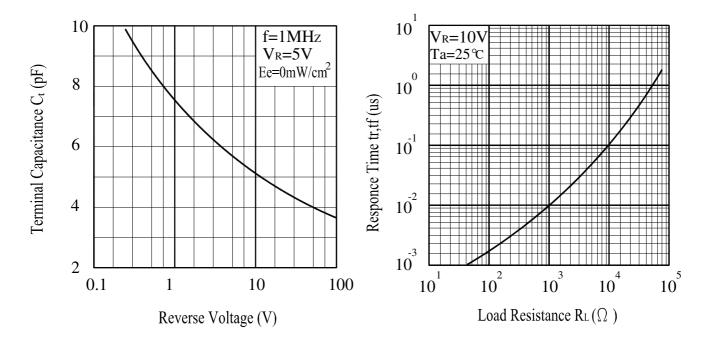
## **Typical Electro-Optical Characteristics Curves**

Fig.5 Terminal Capacitance vs.

Fig.6 Response Time vs.

Reverse Voltage





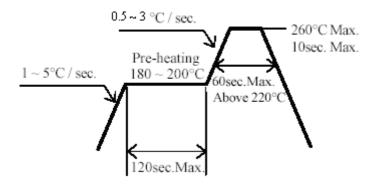


#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
  - 2.3 The LEDs should be used within a year.
  - 2.4 After opening the package, the LEDs should be kept at  $30^{\circ}$ C or less and 70%RH or less.
  - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
  - 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
    Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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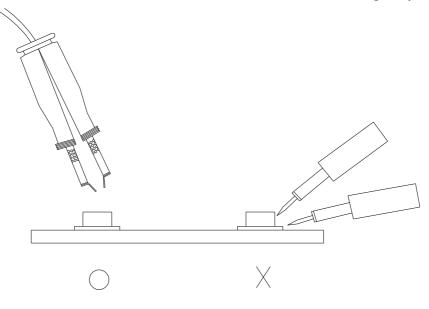


#### 4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





#### **Reliability Test Item And Condition**

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

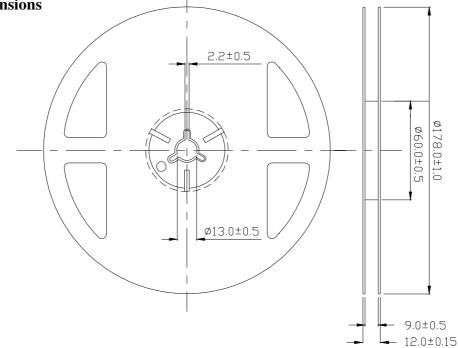
LTPD: 10%

NO.	Item	Test Conditions	Test Hours/	Sample	Failure	Ac/Re
			Cycles	Sizes	Judgement	
					Criteria	
1	<b>REFLOW Soldering</b>	TEMP.∶260°C±5°C	6Mins	22pcs		0/1
		10secs			$I_L \leq L \times 0.8$	
2	Temperature Cycle	H : +100°C 15mins	50Cycles	22pcs		0/1
		5mins			L: Lower	
		$L:-40^{\circ}C$ 15mins			Specification	
3	Thermal Shock	H :+100°C $\blacktriangle$ 5mins	50Cycles	22pcs	Limit	0/1
		✓ 10secs				
		$L:-10^{\circ}C$ 5mins				
4	High Temperature	TEMP. ∶ +100°C	1000hrs	22pcs		0/1
	Storage					
5	Low Temperature	<b>TEMP.</b> ∶ -40°C	1000hrs	22pcs		0/1
	Storage					
6	DC Operating Life	V <sub>R</sub> =5V	1000hrs	22pcs		0/1
7	High Temperature/	85℃ /85% R.H	1000hrs	22pcs		0/1
	High Humidity					



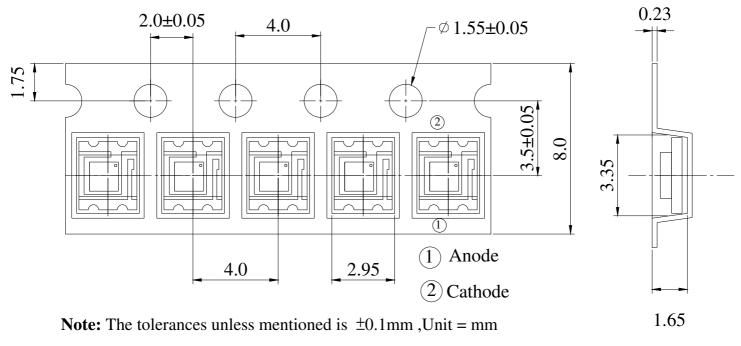
## **Package Dimensions**

1. Reel Dimensions



**Note:** The tolerances unless mentioned is  $\pm 0.1$  mm ,Unit = mm

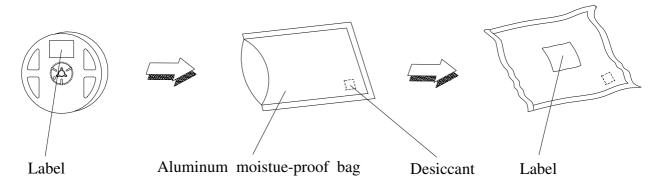
#### 2. Carrier Tape Dimensions:(Quantity: 2000pcs/reel)



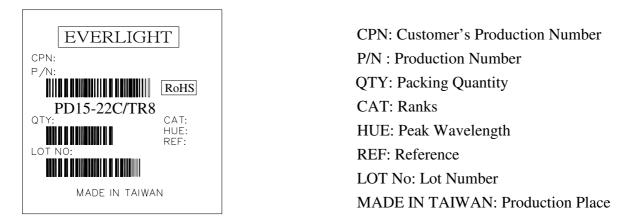
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## **Packing Procedure**



## Label Form Specification



#### Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 3. These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.

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